

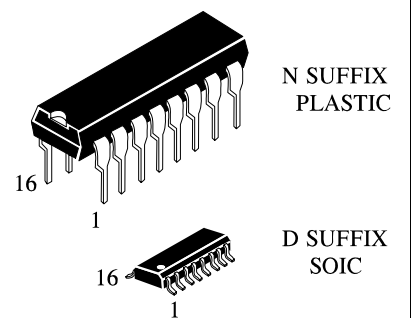
Dual 1-of-4 Decoder/Demultiplexer High-Speed Silicon-Gate CMOS

IN74AC139

The IN74AC139 is identical in pinout to the LS/ALS139, HC/HCT139. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LS/ALS outputs.

This device consists of two independent 1-of-4 decoders, each of which decodes a two-bit Address to one-of-four active-low outputs. Active-low Selects are provided to facilitate the demultiplexing and cascading functions. The demultiplexing function is accomplished by using the Address inputs to select the desired device output, and utilizing the Select as a data input.

- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1.0 μ A; 0.1 μ A @ 25°C
- High Noise Immunity Characteristic of CMOS Devices
- Outputs Source/Sink 24 mA



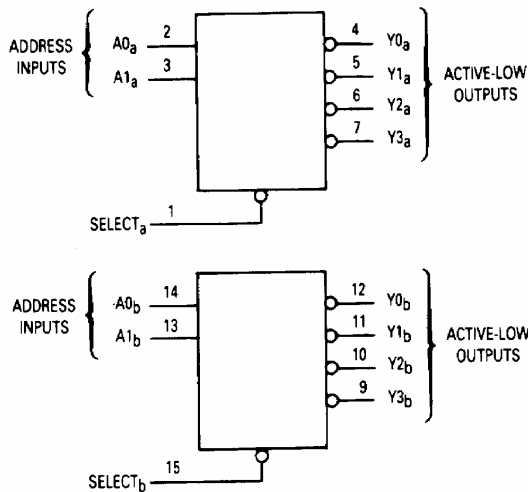
ORDERING INFORMATION

IN74AC139N Plastic

IN74AC139D SOIC

$T_A = -40^\circ$ to 85° C for all packages

LOGIC DIAGRAM



PIN 16 = V_{CC}
PIN 8 = GND

PIN ASSIGNMENT

SELECT _a	1	16	V_{CC}
A0 _a	2	15	SELECT _b
A1 _a	3	14	A0 _b
Y0 _a	4	13	A1 _b
Y1 _a	5	12	Y0 _b
Y2 _a	6	11	Y1 _b
Y3 _a	7	10	Y2 _b
GND	8	9	Y3 _b

FUNCTION TABLE

Inputs			Outputs			
Select	A1	A0	Y0	Y1	Y2	Y3
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	L	H	H	L	H	H
L	H	L	H	H	L	H
L	H	H	H	H	H	L

X = don't care

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
V_{IN}	DC Input Voltage (Referenced to GND)	-0.5 to $V_{CC} + 0.5$	V
V_{OUT}	DC Output Voltage (Referenced to GND)	-0.5 to $V_{CC} + 0.5$	V
I_{IN}	DC Input Current, per Pin	± 20	mA
I_{OUT}	DC Output Sink/Source Current, per Pin	± 50	mA
I_{CC}	DC Supply Current, V_{CC} and GND Pins	± 50	mA
P_D	Power Dissipation in Still Air, Plastic DIP+ SOIC Package+	750 500	mW
T_{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package)	260	°C

*Maximum Ratings are those values beyond which damage to the device may occur.
Functional operation should be restricted to the Recommended Operating Conditions.

+Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C

SOIC Package: - 7 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit	
V _{CC}	DC Supply Voltage (Referenced to GND)	2.0	6.0	V	
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Referenced to GND)	0	V _{CC}	V	
T _J	Junction Temperature (PDIP)		140	°C	
T _A	Operating Temperature, All Package Types	-40	+85	°C	
I _{OH}	Output Current - High		-24	mA	
I _{OL}	Output Current - Low		24	mA	
t _r , t _f	Input Rise and Fall Time * (except Schmitt Inputs)	V _{CC} =3.0 V V _{CC} =4.5 V V _{CC} =5.5 V	0 0 0	150 40 25	ns/V

* V_{IN} from 30% to 70% V_{CC}

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range $GND \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

Symbol	Parameter	Test Conditions	V _{CC} V	Guaranteed Limits		Unit
				25 °C	-40°C to 85°C	
V _{IH}	Minimum High-Level Input Voltage	V _{OUT} =0.1 V or V _{CC} -0.1 V	3.0 4.5 5.5	2.1 3.15 3.85	2.1 3.15 3.85	V
V _{IL}	Maximum Low - Level Input Voltage	V _{OUT} =0.1 V or V _{CC} -0.1 V	3.0 4.5 5.5	0.9 1.35 1.65	0.9 1.35 1.65	V
V _{OH}	Minimum High-Level Output Voltage	I _{OUT} ≤ -50 µA	3.0 4.5 5.5	2.9 4.4 5.4	2.9 4.4 5.4	V
		*V _{IN} =V _{IH} or V _{IL} I _{OH} =-12 mA	3.0	2.56	2.46	
		I _{OH} =-24 mA	4.5	3.86	3.76	
		I _{OH} =-24 mA	5.5	4.86	4.76	
V _{OL}	Maximum Low-Level Output Voltage	I _{OUT} ≤ 50 µA	3.0 4.5 5.5	0.1 0.1 0.1	0.1 0.1 0.1	V
		*V _{IN} =V _{IH} or V _{IL} I _{OL} =12 mA	3.0	0.36	0.44	
		I _{OL} =24 mA	4.5	0.36	0.44	
		I _{OL} =24 mA	5.5	0.36	0.44	
I _{IN}	Maximum Input Leakage Current	V _{IN} =V _{CC} or GND	5.5	±0.1	±1.0	µA
I _{OLD}	+Minimum Dynamic Output Current	V _{OLD} =1.65 V Max	5.5		75	mA
I _{OHD}	+Minimum Dynamic Output Current	V _{OHD} =3.85 V Min	5.5		-75	mA
I _{CC}	Maximum Quiescent Supply Current (per Package)	V _{IN} =V _{CC} or GND	5.5	8.0	80	µA

* All outputs loaded; thresholds on input associated with output under test.

+Maximum test duration 2.0 ms, one output loaded at a time.

Note: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}

AC ELECTRICAL CHARACTERISTICS ($C_L=50\text{pF}$, Input $t_r=t_f=3.0\text{ ns}$)

Symbol	Parameter	V _{CC} [*] V	Guaranteed Limits				Unit
			25 °C		-40°C to 85°C		
			Min	Max	Min	Max	
t _{PLH}	Propagation Delay , Input A to Output Y (Figure 2)	3.3 5.0	4.0 3.0	11.5 8.5	3.5 2.5	13 9.5	ns
t _{PHL}	Propagation Delay , Input A to Output Y (Figure 2)	3.3 5.0	3.0 2.5	10 7.5	2.5 2.0	11 8.5	ns
t _{PLH}	Propagation Delay, Select to Output Y (Figure 1)	3.3 5.0	4.5 3.5	12 8.5	3.5 3.0	13 10	ns
t _{PHL}	Propagation Delay, Select to Output Y (Figure 1)	3.3 5.0	4.0 2.5	10 7.5	3.0 2.5	11 8.5	ns
C _{IN}	Maximum Input Capacitance	5.0	4.5		4.5		pF

C _{PD}	Power Dissipation Capacitance	Typical @25°C,V _{CC} =5.0 V		pF
		40		

*Voltage Range 3.3 V is 3.3 V $\pm$ 0.3 V

Voltage Range 5.0 V is 5.0 V $\pm$ 0.5 V

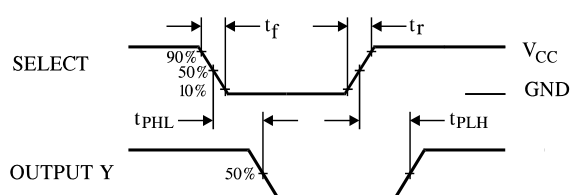


Figure 1. Switching Waveform

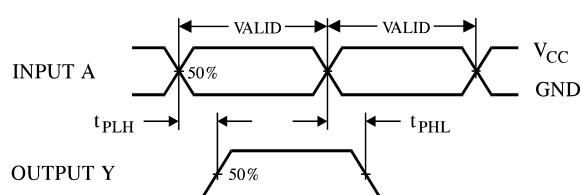
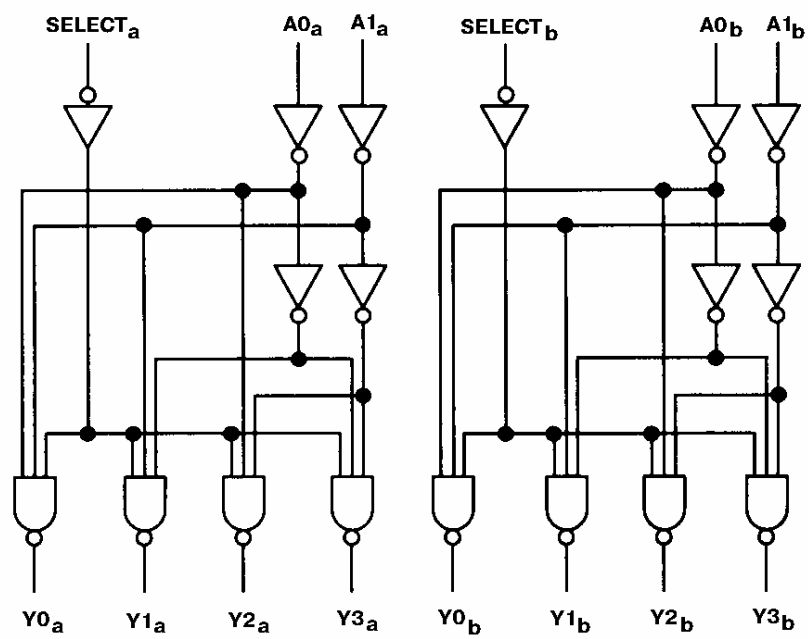
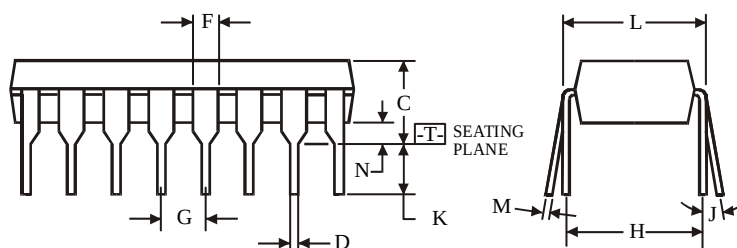
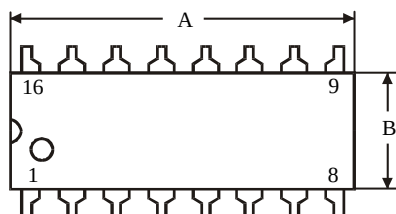
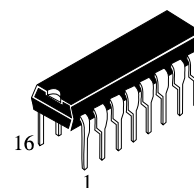


Figure 2. Switching Waveform

EXPANDED LOGIC DIAGRAM



N SUFFIX PLASTIC DIP
(MS - 001BB)



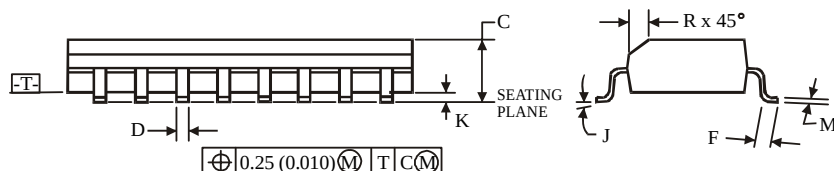
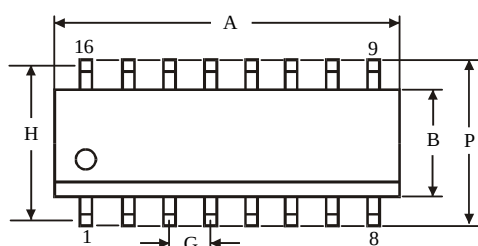
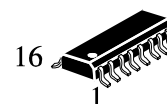
$$\oplus 0.25 (0.010) \text{ (M) } T$$

NOTES:

- Dimensions "A", "B" do not include mold flash or protrusions.
Maximum mold flash or protrusions 0.25 mm (0.010) per side.

	Dimension, mm	
Symbol	MIN	MAX
A	18.67	19.69
B	6.1	7.11
C		5.33
D	0.36	0.56
F	1.14	1.78
G	2.54	
H	7.62	
J	0°	10°
K	2.92	3.81
L	7.62	8.26
M	0.2	0.36
N	0.38	

D SUFFIX SOIC
(MS - 012AC)



$$\oplus 0.25 (0.010) \text{ (M) } T \text{ C (M) }$$

NOTES:

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side
for A; for B - 0.25 mm (0.010) per side.

	Dimension, mm	
Symbol	MIN	MAX
A	9.8	10
B	3.8	4
C	1.35	1.75
D	0.33	0.51
F	0.4	1.27
G	1.27	
H	5.72	
J	0°	8°
K	0.1	0.25
M	0.19	0.25
P	5.8	6.2
R	0.25	0.5

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